

# Summary of caesium evaporation and deposition during SPIDER first campaign

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### SPIDER Cs Ovens

**Cs oven location viewed from the rear side of SPIDER BS**

**Cs oven location viewed in the plasma box after SPIDER dismantling**

- Cs required in the source in order to lower the work function of the surfaces in the Beam Source (BS) and hence to maximize the generation of negative ions by means of the surface mechanism
- 3 Cs ovens installed on the back-plate of the source
- Oven consists of [1][2]:
  - Reservoir in which liquid Cs is stocked
  - Solenoid valve with Kalrez gasket to avoid Cs contamination
  - Duct which connects the reservoir to the nozzle
  - Nozzle with 6 holes through which Cs goes into the BS
  - 3 heating cartridges, 2 for the duct and 1 for the reservoir
  - 5 Thermocouples (TC), 3 on the duct and 2 on the reservoir to have feedback for the PID control on the cartridges power supplies (PS)
  - Surface Ion Detection (SID) diagnostic to estimate the Cs flux through the nozzle
- Cs ovens can be checked and controlled by means of a HMI tool (it is possible to set duct and reservoir temperatures and to set currents and bias voltages for the SID measurements)
- First Cs oven valve aperture in May 2021 (In CATS, Cs flow detected only after at least one hour for first evaporation. In SPIDER it took 20 minutes)

**Cs oven scheme**

**Cs oven HMI**

### SPIDER Cs Ovens inspection

**Nozzle**      **Reservoir**      **Cs Level detector**

- After water leak incident, Cs contaminated in all the reservoirs
- NOTE to REMEMBER: Cs Oven #3 have been switched and placed at the bottom where the leak occurred
- From the top to the bottom Cs seemed less contaminated by water vapor: Cs hydroxide (white compound) is the same formed in CATS facility where uncontrolled impurities flew in the vessel [1]. Cs oxide (yellow compound) has been found after long evaporation campaign even in CATS
- In this condition it is impossible to verify SID measurement in terms of Cs mass evaporated with a simple weighing of the ovens, but SID measurement is reliable [1]
- From SID diagnostic, the total Cs consumed in 172h of evaporation has been **2,411 g (Oven#1: 0,763 g Oven#2: 0,783 g Oven#3: 0,866g)**
- NOTE: as soon as we placed Cs compounds outside the Glove Box, the compounds started to adsorb the air humidity. Droplets began to form and most of the surfaces cleaned themselves in less than 2h

### Cs on Lateral Wall

Plasma touched the surface

- Lateral wall (LW) of BS has 4 permanent magnets installed on its back.
- Looking at the surfaces, it is possible to identify the regions where the plasma "touched" the wall and where it has been shielded
- Inductively Coupled Plasma Mass Spectrometry (ICP-MS) chemical analyses on 5% nitric acid solution impregnated swabs taken in several spots of the surface to determine the Cs deposited
- Top part of the LW "behaves" as thought since there is less Cs where there are the magnets and therefore where the plasma touched the wall
- Lateral part of LW is different. Plasma density changes because of the RF driver location and non uniformity of magnetic field [4]. Cs+ is deposited in the permanent magnet area

### SPIDER Cs Ovens operation

- Cs is a getter material and therefore impurities can contaminate Cs stocked in the reservoir
- Cs handling and sealing before and during ovens installation fundamental
- Picture shows Cs in the reservoir inside a Glove-Box one week after having installed the ovens in the source but with no evaporation: Cs still liquid

**SID feedback**

**TCs feedback**

**Oven #3**

**Oven #2**

**Oven #1**

- SID consists of a pair of tungsten filaments around the nozzle holes
- One filament at A to be hot and ionize the Cs atoms
- Bias voltage between the filaments to detect the Cs ions
- From current and CATS experience it is possible to correlate Cs flux [ref de Muri]
- Pulsed operation (30s plasma ON – 3 minutes OFF)
- Plasma ON: SID system disconnected to avoid failures
- Plasma OFF: SID on the top oven (#3) gives almost immediately the measurement; the one in the middle (#2) only at the end of OFF phase (red area); the one at the bottom (#1) cannot reach a steady state condition in time
- Only correlation found up to now is the nozzle temperature (red curve of TC plots) reached during plasma ON phase

- To confirm this aspect, oven #1 and oven #3 have been switched after SPIDER venting for a maintenance phase. Unfortunately, the water leak incident occurred and SPIDER shut-down started.
- However, this delay response could be furthermore justified by the Macor insulator support for the SID filaments: its resistivity changes with temperature and could affect the measurement.
- Two ways to avoid this behavior: 1) changing the material of the insulator; 2) relying on the new permanent magnets in the case they are going to be installed in the rear side of the BS back-plate (the plasma would be shielded and the nozzle would not reach the temperatures detected previously)

### Cs on EG

**EG grid**

- On EG, stains attributable to the Cs oven location
- ICP-MS analyses and normalization of Cs data to the Cu detected altogether (triangles)
- AVOCADO [3] numerical simulations (blue dots) in the BS in front of the 28 holes left open to see if there is the same trend

### Cs vs numerical model in vacuum

- LAS (Laser Adsorption Spectroscopy) is a diagnostic installed on SPIDER with 4 line of view (white dashed lines) that gives the Cs density both in plasma ON and OFF scenario
- AVOCADO numerical simulations to determine a match with LAS data during Cs evaporation with no plasma [7]
- Data Match setting the bottom oven with a Cs flux reduced of 14%

### Cs cleaning procedures

**Before Pure Water After**

**Before Citric Acid After**

**CO2 pellets**

**Before After Ar glow discharge**

**SEM analyses**

**He glow discharge**

**SEM analyses**

- SPIDER BS and in general HNB BS during experimental campaigns could face open air condition. If Cs has been evaporated, it is necessary to consider Cs cleaning techniques that save time and that are safe (disassembling the BS can be time consuming and not straight forward for radiation reasons)
- SPIDER walls showed different types of "dirty" conditions. White and green powder probably due to the water leak condition. Dark stains on Mo coating due to oxidation
- Main question: What is the requirement for a clean surface?
- Pure water can remove the powders but not the dark stains. Mechanical action is required though
- CO2 dry-ice blasting has the same effect of water but it is not required to touch directly the surface
- Citric or Nitric acid can even remove the dark stains and it can be sprayed over the surface and in less than one minute the coating returns "shiny". Mo coating seems to be not affected.
- Ar glow discharge seems to make the surface even more polluted
- He glow discharge gives the "shiny" effect.
- Glow discharge DO NOT require the BS to be disassembled